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(12) **United States Design Patent**  
**Johnson et al.**

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(54) **RADIO MODEM WITH CIRCUIT BOARD**

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(\*\*) Term: **14 Years**

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(51) **LOC (8) Cl.** ..... **14-03**

(52) **U.S. Cl.** ..... **D14/242**

(58) **Field of Classification Search** ..... D14/240,  
D14/242, 246, 192, 223, 140.1, 140.4, 356,  
D14/358; D13/184, 171, 123, 146, 151;  
181/129-130; 379/430, 431, 433.01, 420.03,  
379/957, 52, 106.1, 333-337, 387.01, 399.01,  
379/413.02, 413.04; 455/569.1, 510, 524;  
439/717

See application file for complete search history.

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Woessner, P.A.

(57) **CLAIM**

The ornamental design for a radio modem with circuit board,  
as shown and described.

**DESCRIPTION**

FIG. 1 is a top plan view of a radio modem with circuit board  
showing our new design;

FIG. 2 is a bottom plan view thereof;

FIG. 3 is a front elevation thereof;

FIG. 4 is a rear elevation thereof;

FIG. 5 is a right-side elevation thereof;

FIG. 6 is a left-side elevation thereof;

FIG. 7 is a top plan view of a modified embodiment of the  
design shown in FIGS. 1 through 6;

FIG. 8 is a bottom plan view thereof;

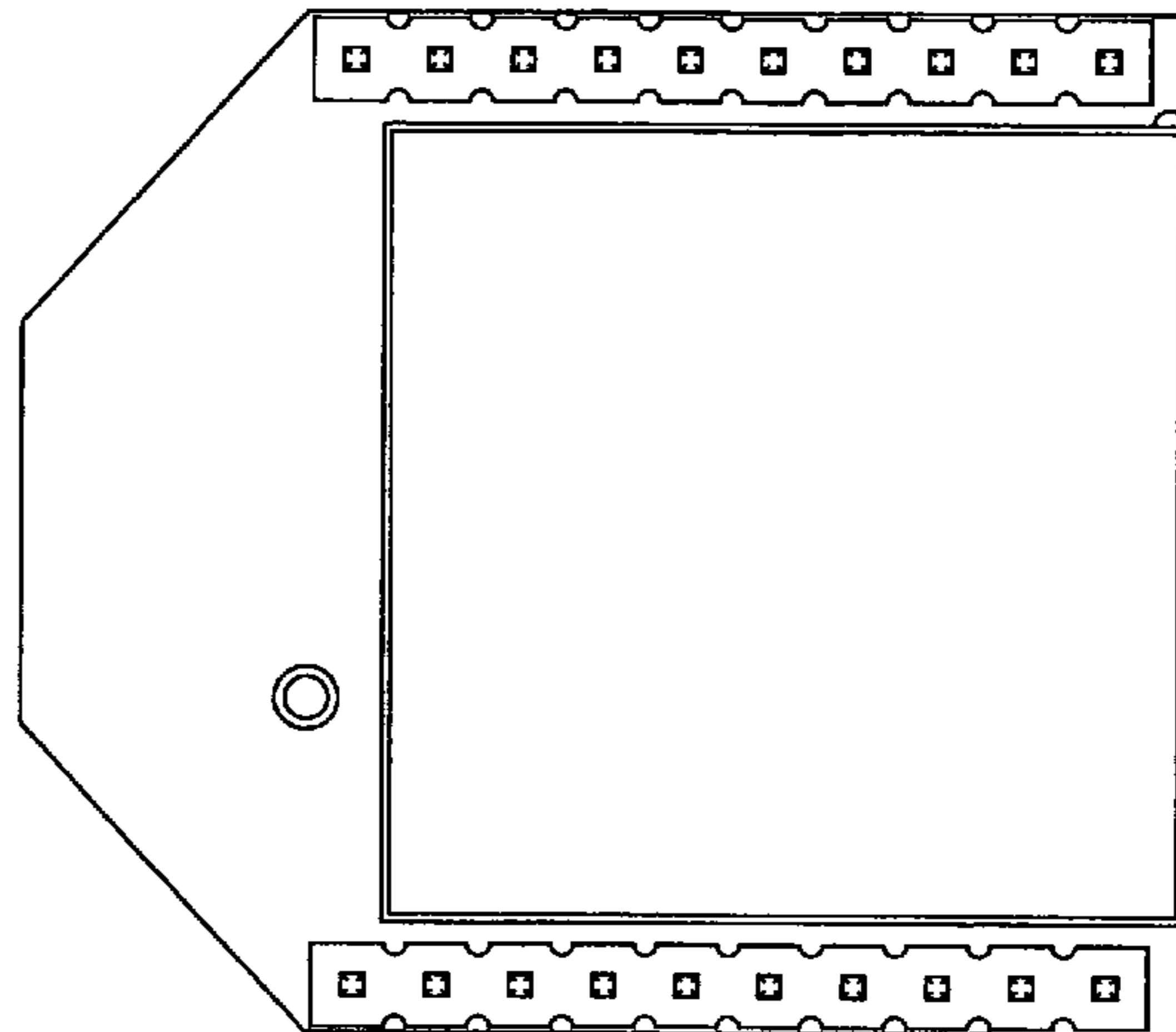
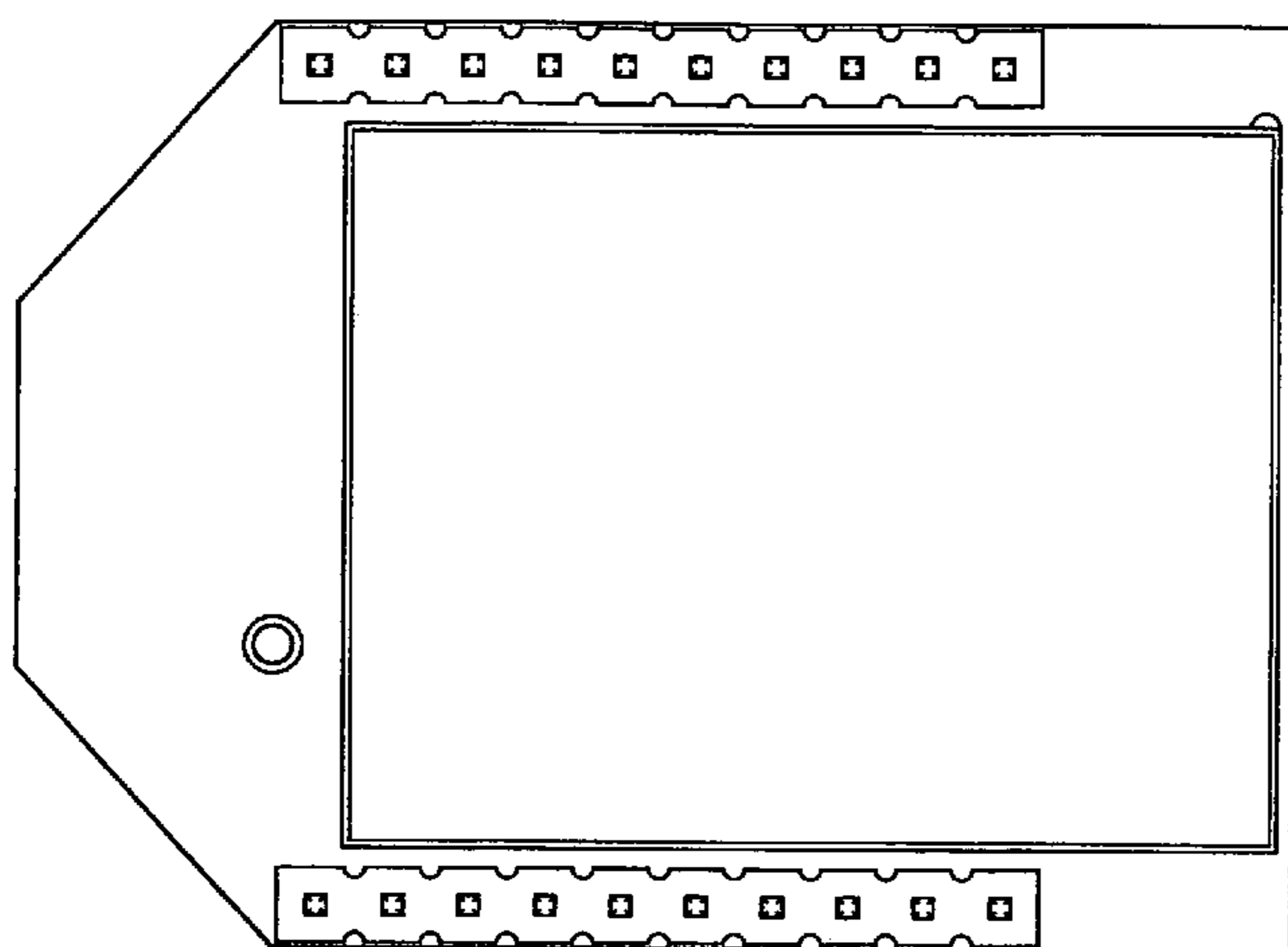
FIG. 9 is a front elevation thereof;

FIG. 10 is a rear elevation thereof;

FIG. 11 is a right-side elevation thereof; and,

FIG. 12 is a left-side elevation thereof.

**1 Claim, 4 Drawing Sheets**



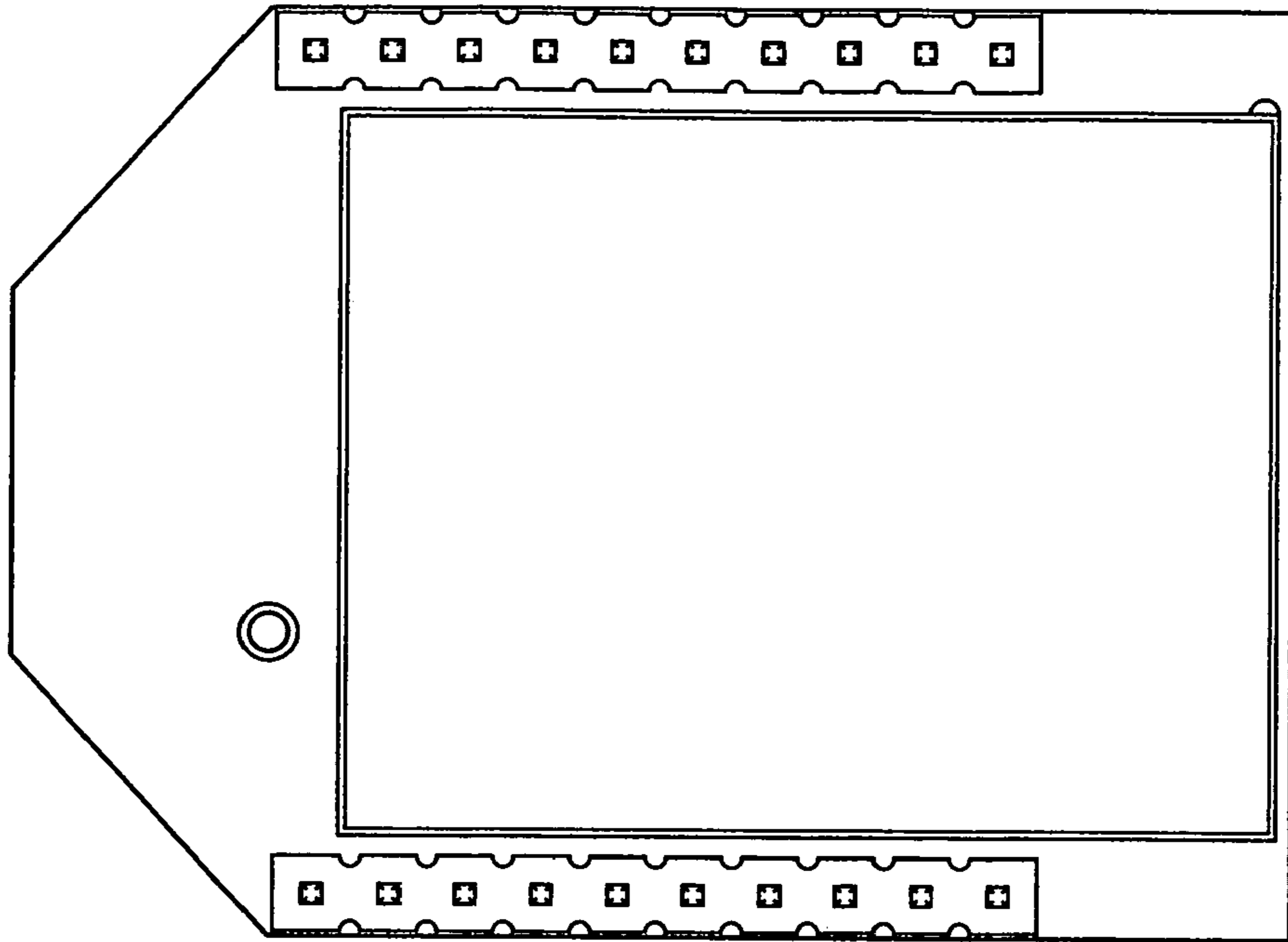


FIG. 1

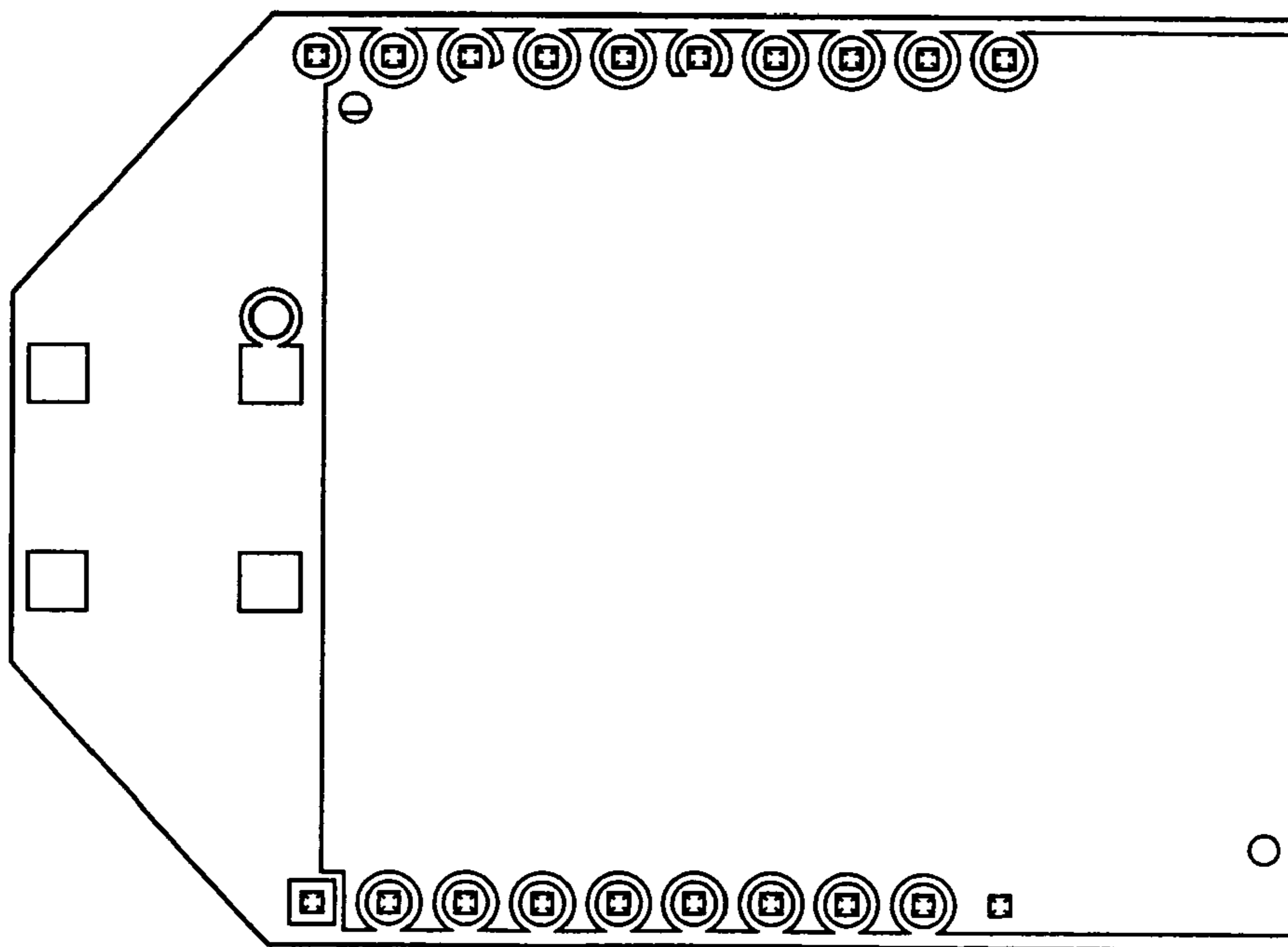


FIG. 2

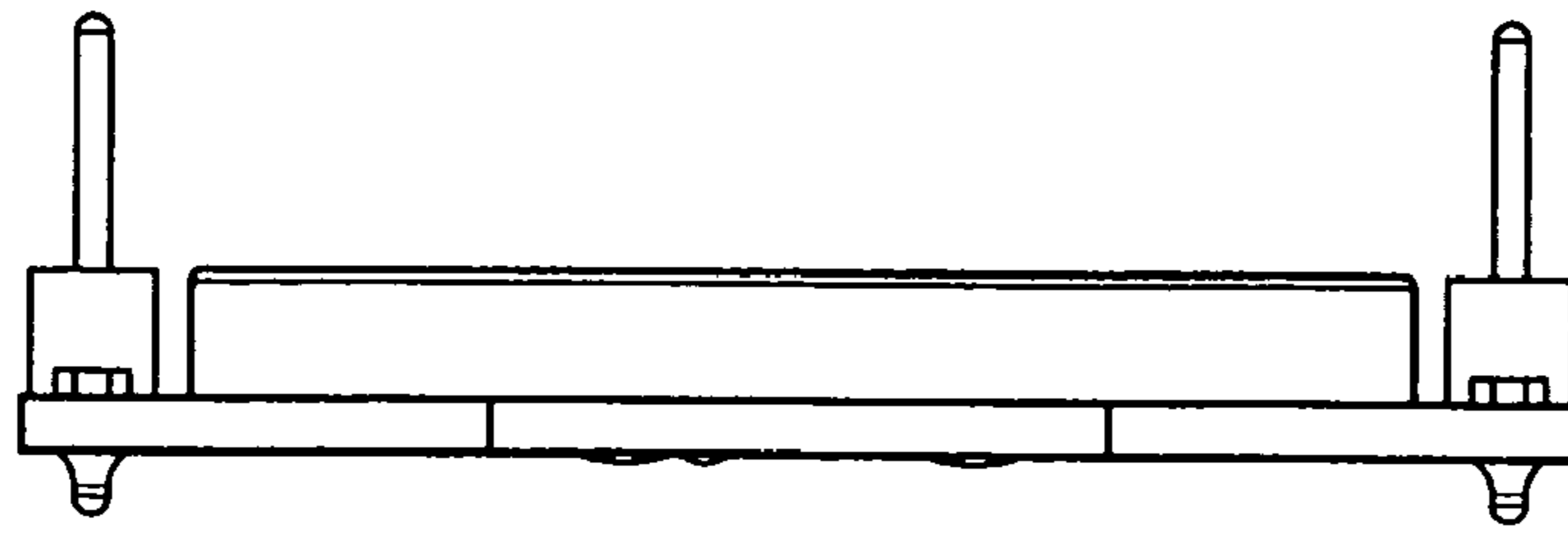


FIG. 3

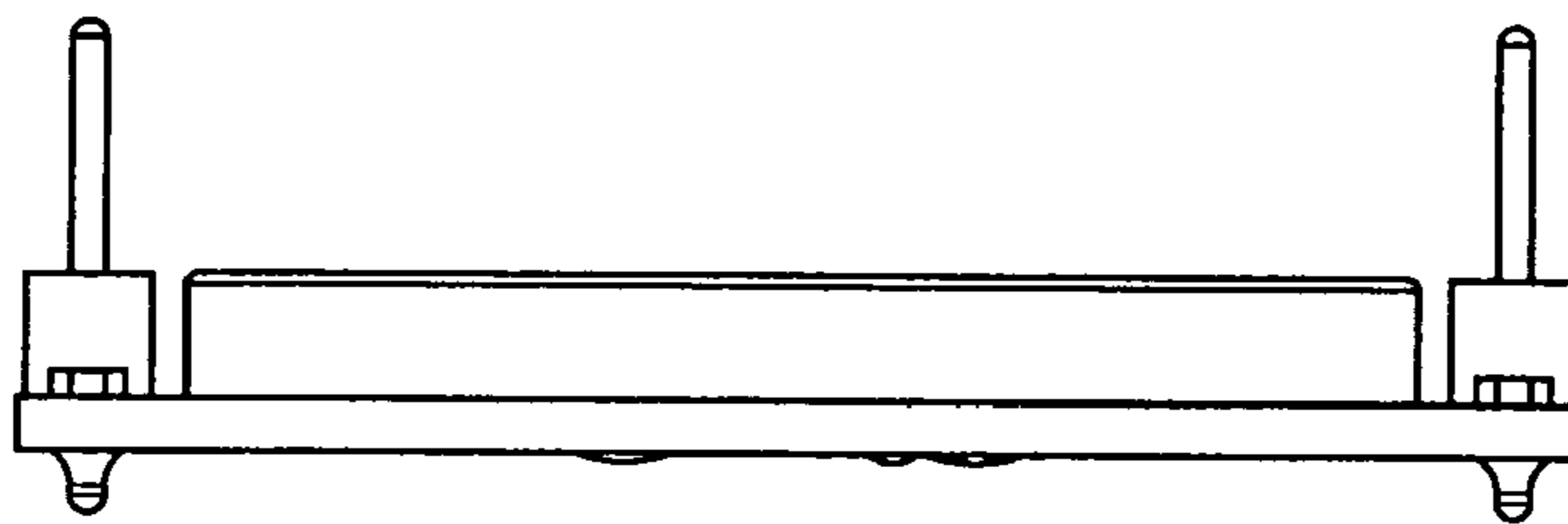


FIG. 4

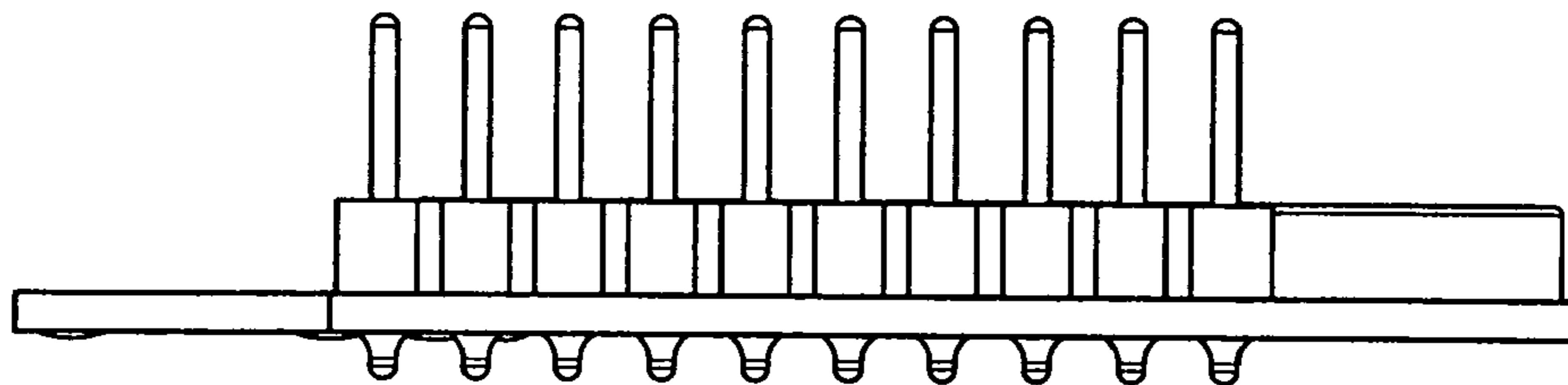


FIG. 5

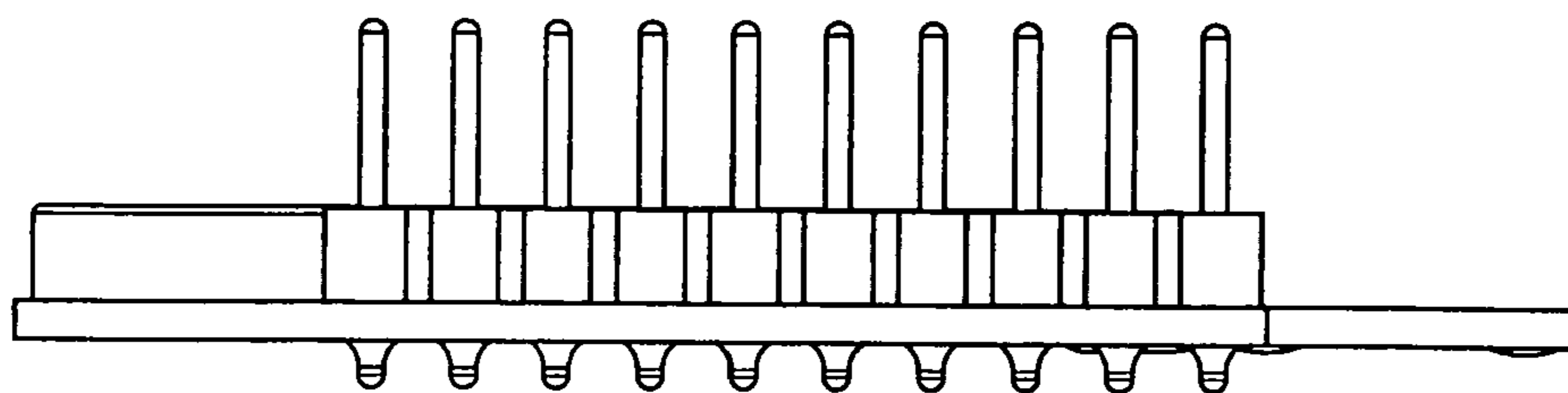


FIG. 6

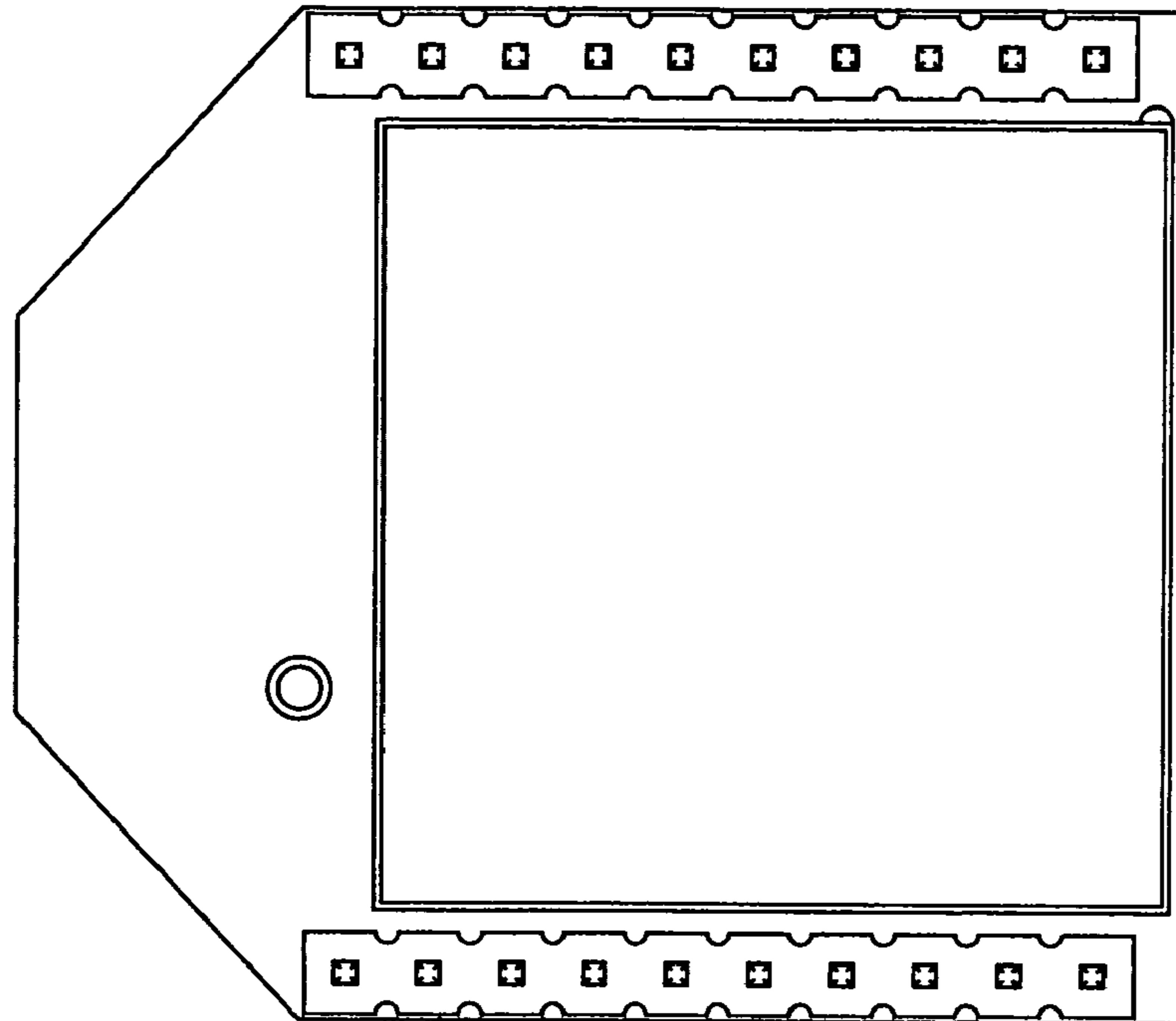


FIG. 7

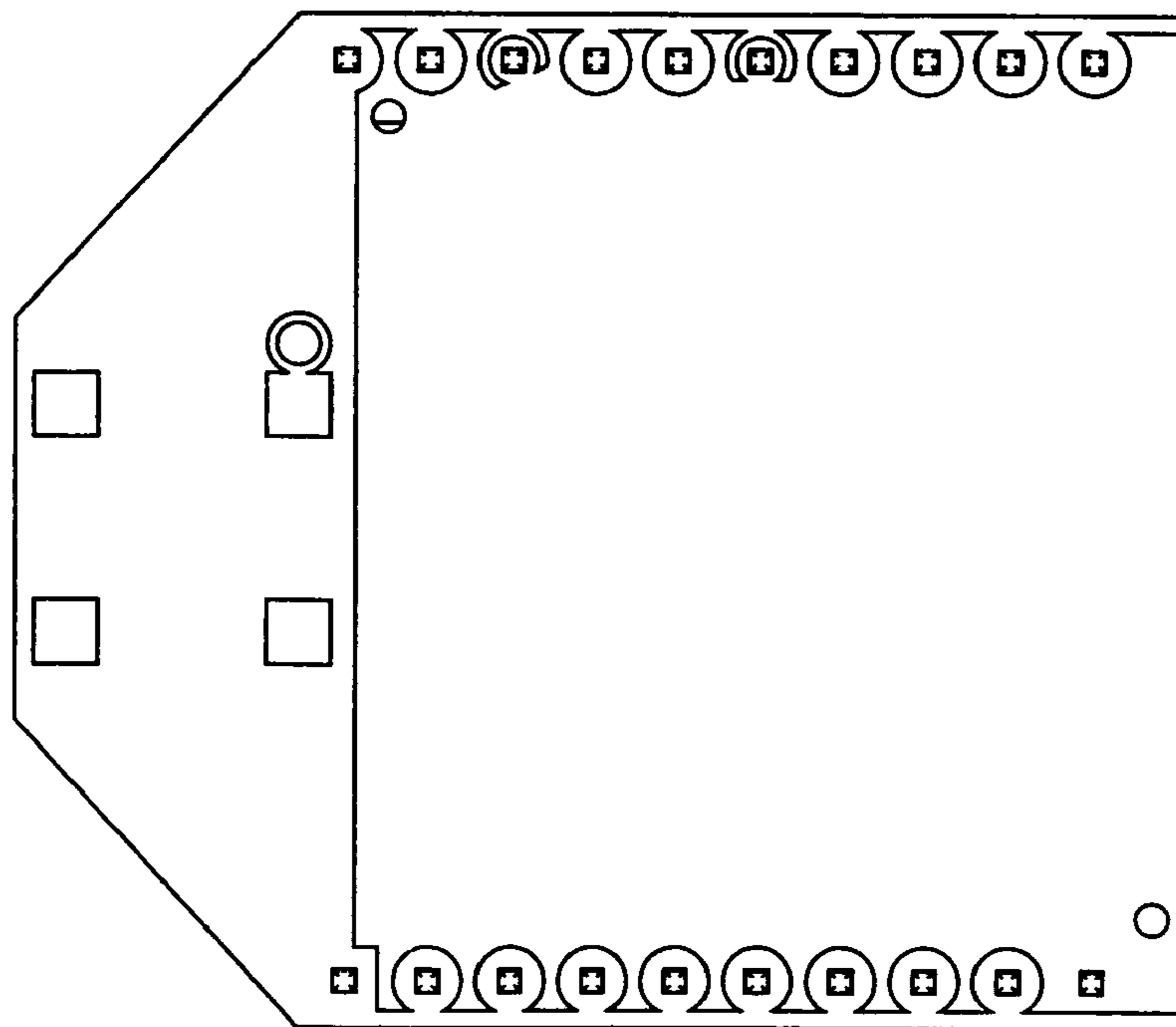


FIG. 8

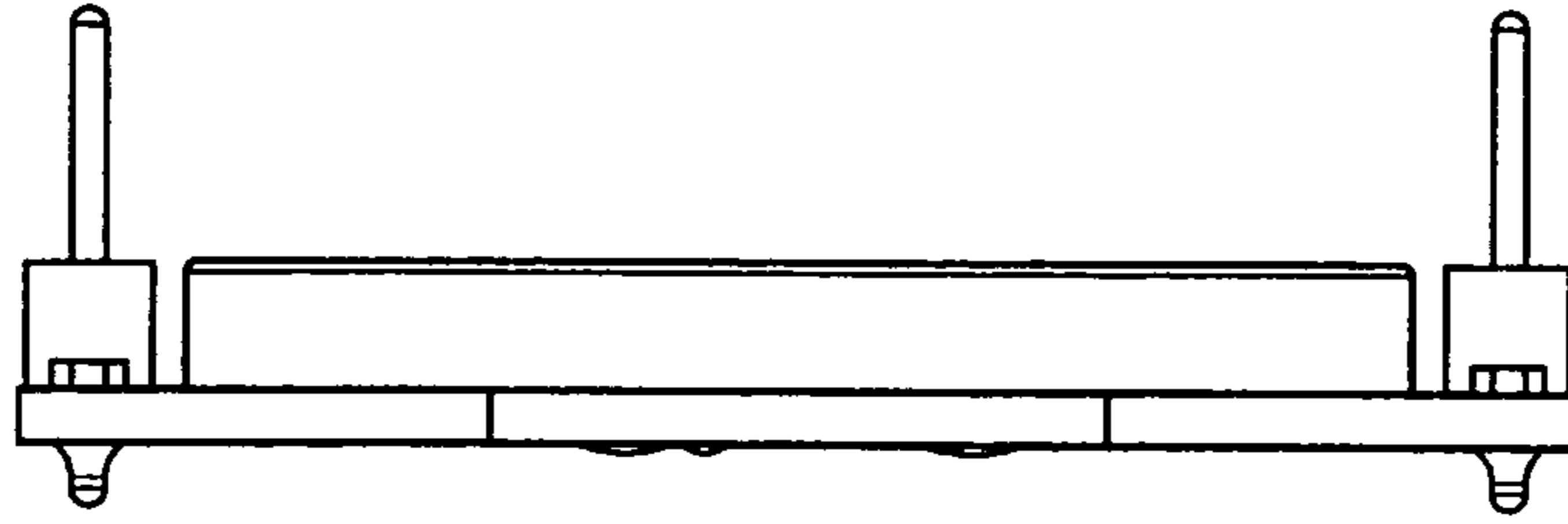


FIG. 9

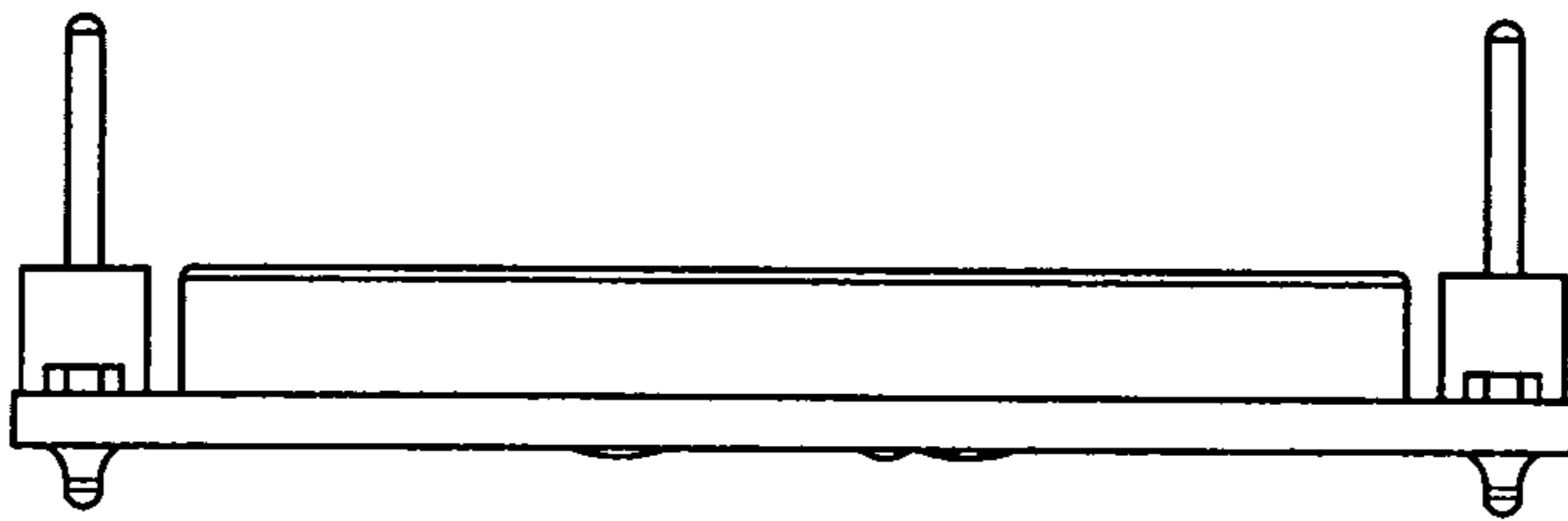


FIG. 10

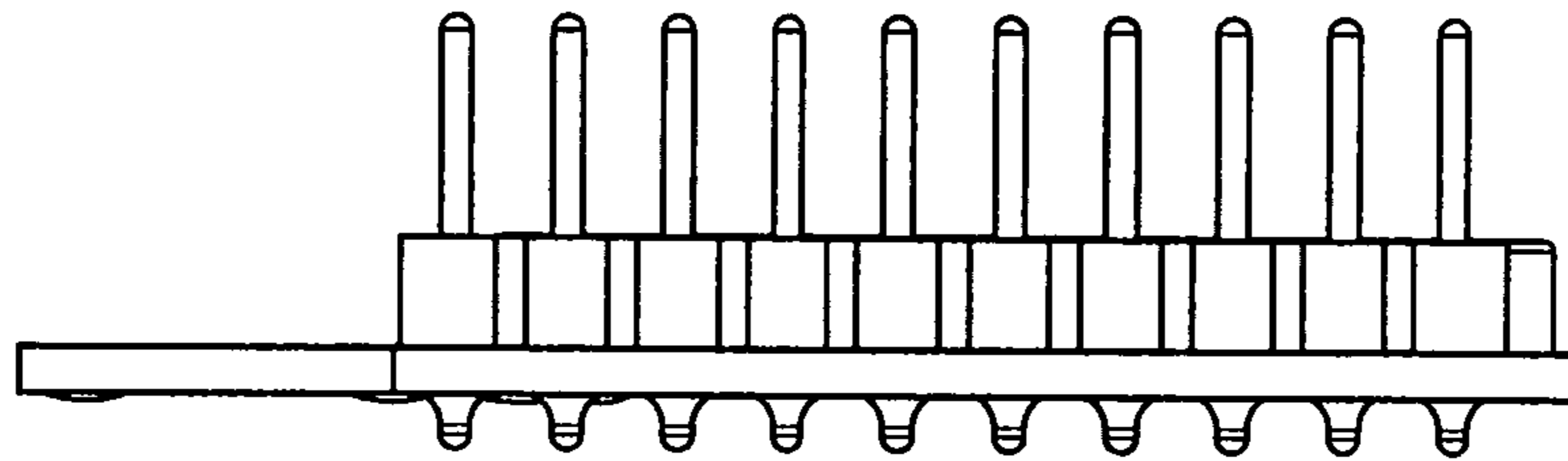


FIG. 11

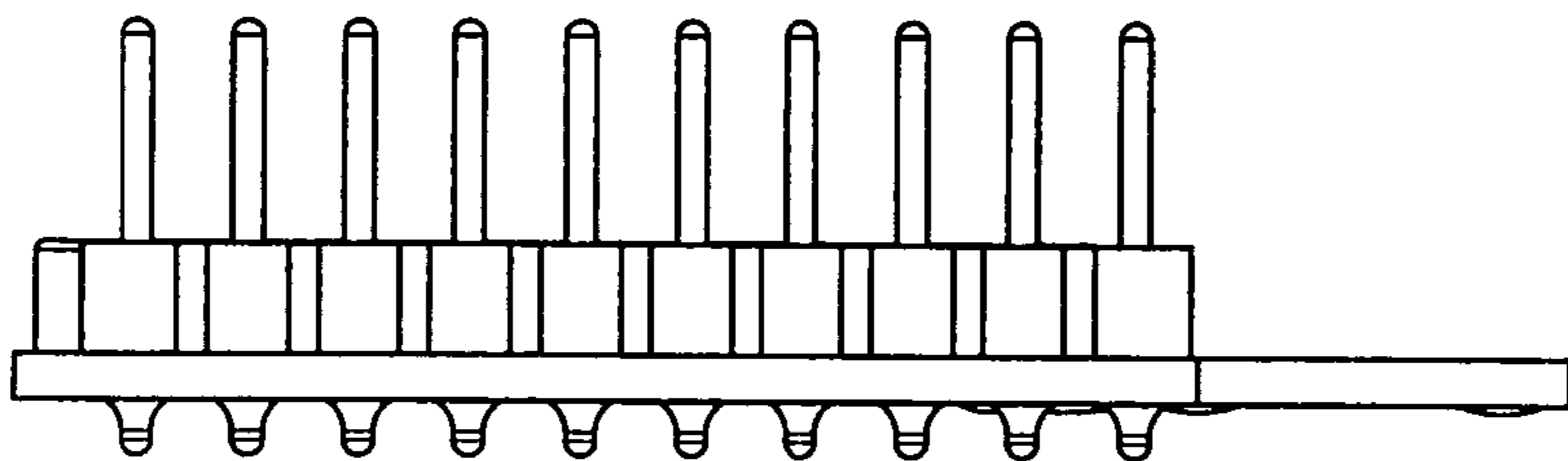


FIG. 12